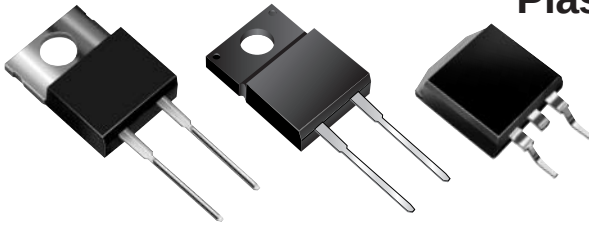
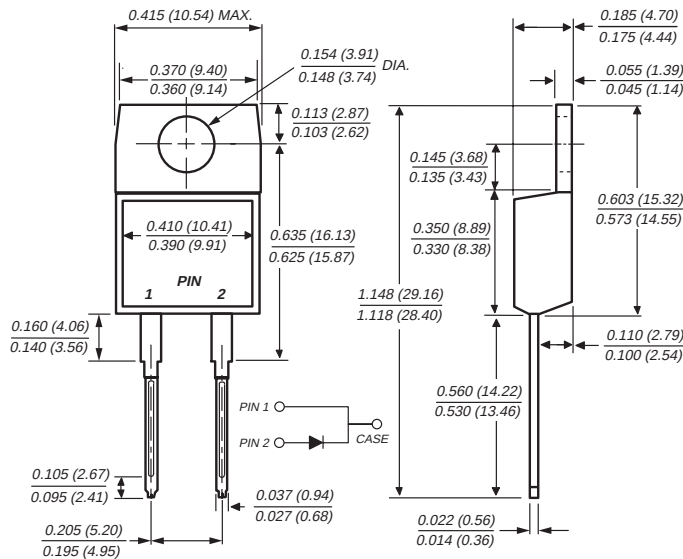
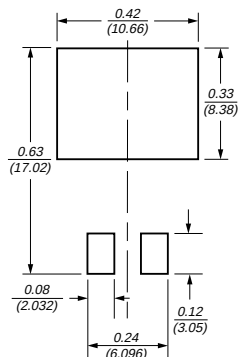
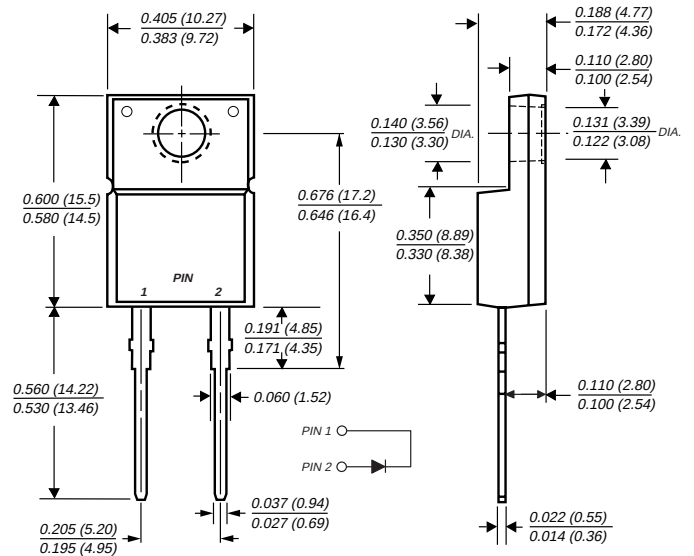
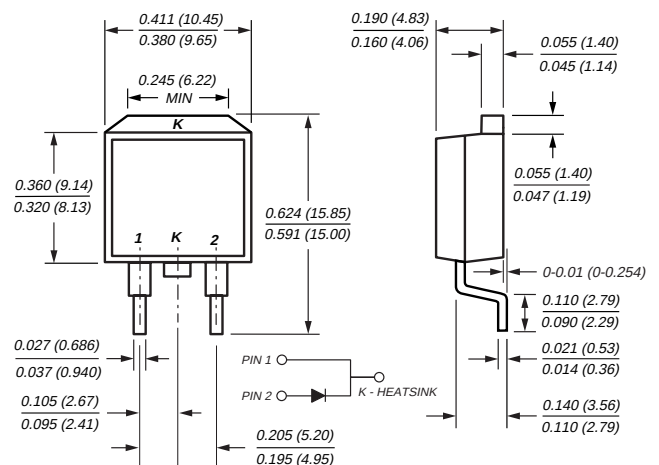


**Glass Passivated General Purpose
Plastic Rectifier****Reverse Voltage** 50 to 1000
Forward Current 8.0A**TO-220AC (NSxT)****Mounting Pad Layout TO-263AB**Dimensions in inches
and (millimeters)**ITO-220AC (NSFxT)****TO-263AB (NSBxT)****Features**

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- High forward current capability
- High surge current capability
- Low forward voltage drop
- Glass passivated chip junction
- High temperature soldering guaranteed: 260°C/10 seconds, 0.160" (4.06mm) lead length

Mechanical Data**Case:** JEDEC TO-220AC, ITO-220AC & TO-263AB molded plastic body**Terminals:** Plated leads solderable per MIL-STD-750, Method 2026**Polarity:** As marked**Mounting Torque:** 10 in. -lbs. max.**Mounting Position:** Any**Weight:** 0.064 ounce, 1.81 grams

Maximum Ratings & Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	NS8 AT	NS8 BT	NS8 DT	NS8 GT	NS8 JT	NS8 KT	NS8 MT	Units
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_C=100^{\circ}\text{C}$	$I_{F(AV)}$	8.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	125							A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150							$^{\circ}\text{C}$
RMS Isolation voltage (NSF type only) from terminals to heatsink with $t = 1.0$ second, $RH \leq 30\%$	V_{ISOL}	4500 ⁽¹⁾ 3500 ⁽²⁾ 1500 ⁽³⁾							V

Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	NS8 AT	NS8 BT	NS8 DT	NS8 GT	NS8 JT	NS8 KT	NS8 MT	Units
Maximum instantaneous forward voltage at 8.0A	V_F	1.1							V
Maximum DC reverse current at rated DC blocking voltage $T_C=25^{\circ}\text{C}$ $T_C=100^{\circ}\text{C}$	I_R	10 100							μA
Typical junction capacitance at 4.0V, 1MHz	C_J	55							pF

Thermal Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	NSxT	NSFxt	NSBxt	Units
Typical thermal resistance ⁽⁴⁾	$R_{\theta JC}$	3.0	5.0	3.0	$^{\circ}\text{C/W}$

Notes:

- (1) Clip mounting (on case), where lead does not overlap heatsink with 0.110" offset
- (2) Clip mounting (on case), where leads do overlap heatsink
- (3) Screw mounting with 4-40 screw, where washer diameter is $\leq 4.9\text{mm}$ (0.19")
- (4) Thermal resistance from junction to case mounted on heat sink

Ratings and Characteristic Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 1 – Forward Current Derating Curve

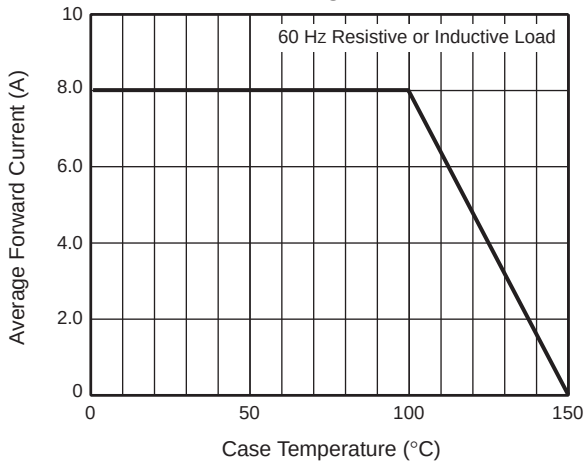


Fig. 2 – Maximum Non-Repetitive Peak Forward Surge Current

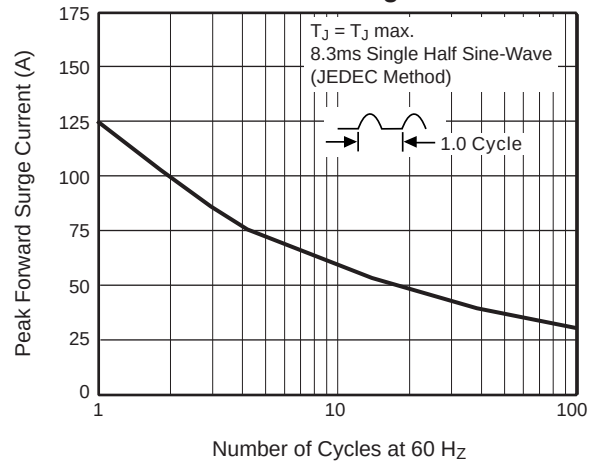


Fig. 3 – Typical Instantaneous Forward Characteristics

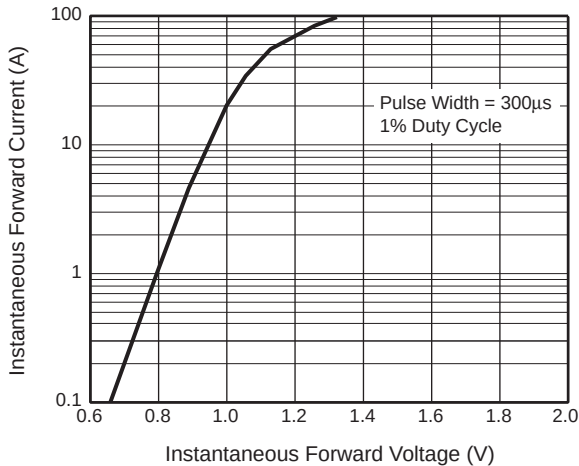


Fig. 4 – Typical Reverse Characteristics

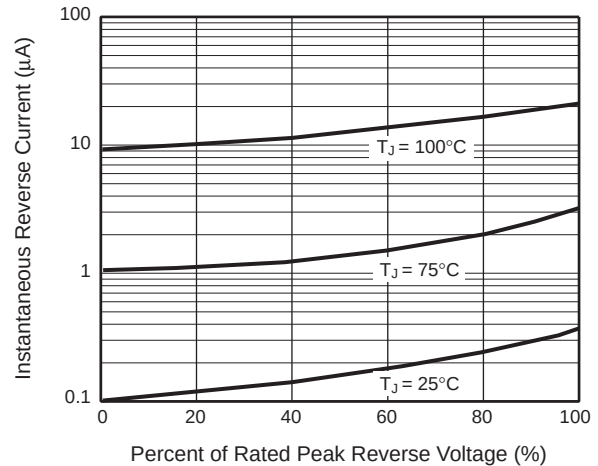


Fig. 5 – Typical Junction Capacitance Per Leg

